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Bib Data Sheet

CONFIRMATION NO. 5528

|  |   |                           |  |                                    |                         |
|--|---|---------------------------|--|------------------------------------|-------------------------|
| SERIAL NUMBER<br>10/825,246  | FILING DATE<br>04/16/2004<br><br>RULE   | CLASS<br>257              | GROUP ART UNIT<br>2811   | ATTORNEY DOCKET NO.<br>8001-1049-1 |                         |
| <b>APPLICANTS</b><br><br>Hirokazu Miyazaki, Tokyo, JAPAN;  |   |                           |  |                                    |                         |
| <b>** CONTINUING DATA</b> *****<br><i>[Signature]</i><br>This application is a DIV of 09/788,596 02/21/2001 PAT 6,803,647  |   |                           |  |                                    |                         |
| <b>** FOREIGN APPLICATIONS</b> *****<br><i>[Signature]</i><br>JAPAN 2000-049904 02/25/2000   |   |                           |  |                                    |                         |
| <b>IF REQUIRED, FOREIGN FILING LICENSE GRANTED</b><br><b>** 08/10/2004</b>   |   |                           |  |                                    |                         |
| Foreign Priority claimed <input checked="" type="checkbox"/> yes <input type="checkbox"/> no<br>35 USC 119 (a-d) conditions met <input checked="" type="checkbox"/> yes <input type="checkbox"/> no <input type="checkbox"/> Met after<br>Verified and Acknowledged <i>[Signature]</i> <i>[Initials]</i><br>Examiner's Signature    Initials |   | STATE OR COUNTRY<br>JAPAN | SHEETS<br>DRAWING<br>5   | TOTAL CLAIMS<br>4                  | INDEPENDENT CLAIMS<br>3 |
| <b>ADDRESS</b><br>000466<br>YOUNG & THOMPSON<br>745 SOUTH 23RD STREET.<br>2ND FLOOR<br>ARLINGTON , VA<br>22202   |   |                           |  |                                    |                         |
| <b>TITLE</b><br>Mounting structure of semiconductor device and mounting method thereof   |   |                           |  |                                    |                         |
| FILING FEE<br>RECEIVED<br>770  | FEES: Authority has been given in Paper<br>No. _____ to charge/credit DEPOSIT ACCOUNT<br>No. _____ for following: |                           | <input type="checkbox"/> All Fees<br><input type="checkbox"/> 1.16 Fees ( Filing )<br><input type="checkbox"/> 1.17 Fees ( Processing Ext. of time )<br><input type="checkbox"/> 1.18 Fees ( Issue ) |                                    |                         |